

- Member of the Texas Instruments Widebus+™ Family
- UBT™ Transceiver Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 5.4 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Simultaneously Generates and Checks Parity
- Option to Select Generate Parity and Check or Feed-Through Data/Parity in A-to-B or B-to-A Direction
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- I_{off} Supports Partial-Power-Down Mode Operation
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class I
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

DGG PACKAGE
(TOP VIEW)

1CLKENAB	1	64	1CLKENBA
LEAB	2	63	LEBA
CLKAB	3	62	CLKBA
1ERRA	4	61	1ERRB
1APAR	5	60	1BPAP
GND	6	59	GND
1A1	7	58	1B1
1A2	8	57	1B2
1A3	9	56	1B3
V _{CC}	10	55	V _{CC}
1A4	11	54	1B4
1A5	12	53	1B5
1A6	13	52	1B6
GND	14	51	GND
1A7	15	50	1B7
1A8	16	49	1B8
2A1	17	48	2B1
2A2	18	47	2B2
GND	19	46	GND
2A3	20	45	2B3
2A4	21	44	2B4
2A5	22	43	2B5
V _{CC}	23	42	V _{CC}
2A6	24	41	2B6
2A7	25	40	2B7
2A8	26	39	2B8
GND	27	38	GND
2APAR	28	37	2BPAP
2ERRA	29	36	2ERRB
OEAB	30	35	OEBAB
SEL	31	34	ODD/EVEN
2CLKENAB	32	33	2CLKENBA

description/ordering information

This 18-bit (dual-octal) noninverting registered transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVCH16901 is a dual 9-bit to dual 9-bit parity transceiver with registers. The device can operate as a feed-through transceiver, or it can generate/check parity from the two 8-bit data buses in either direction.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	TSSOP – DGG	Tape and reel	SN74LVCH16901DGGR	LVCH16901

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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SN74LVCH16901

18-BIT UNIVERSAL BUS TRANSCEIVER

WITH PARITY GENERATORS/CHECKERS

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description/ordering information (continued)

The SN74LVCH16901 features independent clock (CLKAB or CLKBA), latch-enable (LEAB or LEBA), and dual 9-bit clock-enable ($\overline{\text{CLKENAB}}$ or $\overline{\text{CLKENBA}}$) inputs. It also provides parity-enable ($\overline{\text{SEL}}$) and parity-select (ODD/ $\overline{\text{EVEN}}$) inputs and separate error-signal ($\overline{\text{ERRA}}$ or $\overline{\text{ERRB}}$) outputs for checking parity. The direction of data flow is controlled by output-enable ($\overline{\text{OEAB}}$ and $\overline{\text{OEBA}}$) inputs. When $\overline{\text{SEL}}$ is low, the parity functions are enabled. When $\overline{\text{SEL}}$ is high, the parity functions are disabled, and the device acts as an 18-bit registered transceiver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Function Tables

FUNCTION†					OUTPUT B
INPUTS					
CLKENAB	OEAB	LEAB	CLKAB	A	
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B ₀ [‡]
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L	X	B ₀ [‡]
L	L	L	H	X	B ₀ [§]

† A-to-B data flow is shown; B-to-A flow is similar, but uses $\overline{\text{OEBA}}$, LEBA, and $\overline{\text{CLKENBA}}$.

‡ Output level before the indicated steady-state input conditions were established

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

PARITY ENABLE

INPUTS			OPERATION OR FUNCTION
$\overline{\text{SEL}}$	$\overline{\text{OEBA}}$	$\overline{\text{OEAB}}$	
L	H	L	Parity is checked on port A and is generated on port B.
L	L	H	Parity is checked on port B and is generated on port A.
L	H	H	Parity is checked on port B and port A.
L	L	L	Parity is generated on port A and B if device is in FF mode.
H	L	L	Parity functions are disabled; device acts as a standard 18-bit registered transceiver.
H	L	H	
H	H	L	
H	H	H	

Q_A data to B, Q_B data to A
 Q_B data to A
 Q_A data to B
 Isolation



Function Tables (Continued)

PARITY											
INPUTS								OUTPUTS			
SEL	OEBA	OEAB	ODD/EVEN	Σ OF INPUTS A1–A8 = H	Σ OF INPUTS B1–B8 = H	APAR	BPAR	APAR	ERRA	BPAR	ERRB
L	H	L	L	0, 2, 4, 6, 8	N/A	L	N/A	N/A	H	L	Z
L	H	L	L	1, 3, 5, 7	N/A	L	N/A	N/A	L	H	Z
L	H	L	L	0, 2, 4, 6, 8	N/A	H	N/A	N/A	L	L	Z
L	H	L	L	1, 3, 5, 7	N/A	H	N/A	N/A	H	H	Z
L	L	H	L	N/A	0, 2, 4, 6, 8	N/A	L	L	Z	N/A	H
L	L	H	L	N/A	1, 3, 5, 7	N/A	L	H	Z	N/A	L
L	L	H	L	N/A	0, 2, 4, 6, 8	N/A	H	L	Z	N/A	L
L	L	H	L	N/A	1, 3, 5, 7	N/A	H	H	Z	N/A	H
L	H	L	H	0, 2, 4, 6, 8	N/A	L	N/A	N/A	L	H	Z
L	H	L	H	1, 3, 5, 7	N/A	L	N/A	N/A	H	L	Z
L	H	L	H	0, 2, 4, 6, 8	N/A	H	N/A	N/A	H	H	Z
L	H	L	H	1, 3, 5, 7	N/A	H	N/A	N/A	L	L	Z
L	L	H	H	N/A	0, 2, 4, 6, 8	N/A	L	H	Z	N/A	L
L	L	H	H	N/A	1, 3, 5, 7	N/A	L	L	Z	N/A	H
L	L	H	H	N/A	0, 2, 4, 6, 8	N/A	H	H	Z	N/A	H
L	L	H	H	N/A	1, 3, 5, 7	N/A	H	H	L	Z	L
L	H	H	L	0, 2, 4, 6, 8	0, 2, 4, 6, 8	L	L	Z	H	Z	H
L	H	H	L	1, 3, 5, 7	1, 3, 5, 7	L	L	Z	L	Z	L
L	H	H	L	0, 2, 4, 6, 8	0, 2, 4, 6, 8	H	H	Z	L	Z	L
L	H	H	L	1, 3, 5, 7	1, 3, 5, 7	H	H	Z	H	Z	H
L	H	H	L	0, 2, 4, 6, 8	0, 2, 4, 6, 8	L	L	Z	L	Z	L
L	H	H	L	1, 3, 5, 7	1, 3, 5, 7	L	L	Z	H	Z	H
L	H	H	L	0, 2, 4, 6, 8	0, 2, 4, 6, 8	H	H	Z	H	Z	H
L	H	H	L	1, 3, 5, 7	1, 3, 5, 7	H	H	Z	L	Z	L
L	L	L	L	N/A	N/A	N/A	N/A	PE†	Z	PE†	Z
L	L	L	H	N/A	N/A	N/A	N/A	PO‡	Z	PO‡	Z

† Parity output is set to the level so that the specific bus side is set to even parity.

‡ Parity output is set to the level so that the specific bus side is set to odd parity.

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The diagram illustrates the internal structure of the A-Port and B-Port Parity and Check Data Generator and Checker. It consists of two main processing blocks: 'A-Port Parity Generate and Check B Data' and 'B-Port Parity Generate and Check A Data'. Each block has 18-bit data inputs and outputs, and 2-bit parity inputs and outputs. The blocks are connected via 18-bit data buses (QA and QB) and 2-bit parity buses. Control signals include LEAB, 1CLKENAB, 2CLKENAB, CLKAB, OEAB, OEBAB, ODD/EVEN, and SEL. The diagram also shows the internal 18-bit storage blocks and the 2-bit parity storage blocks.

Supply voltage range, V_{CC}	−0.5 V to 6.5 V
Input voltage range, V_I (see Note 1)	−0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	−0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2)	−0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	−50 mA
Output clamp current, I_{OK} ($V_O < 0$)	−50 mA
Continuous output current, I_O	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3)	55°C/W
Storage temperature range, T_{stg}	−65°C to 150°C

NOTES:

1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The value of V_{CC} is provided in the recommended operating conditions table.
3. The package thermal impedance is calculated in accordance with JEDEC 51-7.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT	
V _{CC}	Supply voltage	Operating	1.65	3.6	V
		Data retention only	1.5		
V _{IH}	High-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}		V
		V _{CC} = 2.3 V to 2.7 V	1.7		
		V _{CC} = 2.7 V to 3.6 V	2		
V _{IL}	Low-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.35 × V _{CC}		V
		V _{CC} = 2.3 V to 2.7 V	0.7		
		V _{CC} = 2.7 V to 3.6 V	0.8		
V _I	Input voltage	0	5.5	V	
V _O	Output voltage	High or low state	0	V _{CC}	V
		3-state	0	5.5	
I _{OH}	High-level output current	V _{CC} = 1.65 V	−4		mA
		V _{CC} = 2.3 V	−8		
		V _{CC} = 2.7 V	−12		
		V _{CC} = 3 V	−24		
I _{OL}	Low-level output current	V _{CC} = 1.65 V	4		mA
		V _{CC} = 2.3 V	8		
		V _{CC} = 2.7 V	12		
		V _{CC} = 3 V	24		
Δt/Δv	Input transition rise or fall rate	5		ns/V	
T _A	Operating free-air temperature	−40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = –100 µA	1.65 V to 3.6 V	V _{CC} –0.2			V
		I _{OH} = –4 mA	1.65 V	1.2			
		I _{OH} = –8 mA	2.3 V	1.7			
		I _{OH} = –12 mA	2.7 V	2.2			
			3 V	2.4			
		I _{OH} = –24 mA	3 V	2.2			
V _{OL}		I _{OL} = 100 µA	1.65 V to 3.6 V			0.2	V
		I _{OL} = 4 mA	1.65 V			0.45	
		I _{OL} = 8 mA	2.3 V			0.7	
		I _{OL} = 12 mA	2.7 V			0.4	
		I _{OL} = 24 mA	3 V			0.55	
I _I	Control inputs	V _I = 0 to 5.5 V	3.6 V			±5	µA
I _I (hold)	A or B ports	V _I = 0.58 V	1.65 V	25			µA
		V _I = 1.07 V		–25			
		V _I = 0.7 V	2.3 V	45			
		V _I = 1.7 V		–45			
		V _I = 0.8 V	3 V	75			
		V _I = 2 V		–75			
		V _I = 0 to 3.6 V‡	3.6 V			±600	
I _{off}		V _I or V _O = 5.5 V	0			±10	µA
I _{OZ} §		V _O = 0 to 5.5 V	3.6 V			±10	µA
I _{CC}		V _I = V _{CC} or GND	3.6 V			20	µA
		3.6 V ≤ V _I ≤ 5.5 V¶				20	
		I _O = 0					
ΔI _{CC}		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	µA
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V		7		pF
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V		9.5		pF

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current, but not I_I(hold).

¶ This applies in the disabled state only.



timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			V _{CC} = 1.8 V†		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		125		125		125		125		MHz
t _w	Pulse duration	CLK↑	4		3		3		3		ns
		LE high	3		3		3		3		
t _{su}	Setup time	A, APAR or B, BPAR before CLK↑	4.7		2.7		2.8		2.5		ns
		CLKEN before CLK↑	4.5		2.9		2.9		2.5		
		A, APAR or B, BPAR before LE↓	0		2.2		2.1		2		
t _h	Hold time	A, APAR or B, BPAR after CLK↑	0		1.2		1.2		1.3		ns
		CLKEN after CLK↑	0		1.3		1.3		1.5		
		A, APAR or B, BPAR after LE↓	1		1.7		1.9		1.7		

[†] Texas Instruments SPICE simulation data

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V†		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
			MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			125		125		125		125		MHz
t _{pd}	A or B	B or A	5.9		1 6.2		5.8		1 5.4		ns
		BPAR or APAR	12.7		2 9.9		8.6		2 7.7		
	APAR or BPAR	BPAR or APAR	7		1 6.7		6.2		1 5.7		
		ERRA or ERRB	13		2 10.7		9.7		2 8.5		
	ODD/EVEN	ERRA or ERRB	9.9		1.5 9.7		8.9		1.5 7.8		
		BPAR or APAR	10.4		1.5 9.3		8.6		1.5 7.5		
	SEL	BPAR or APAR	6.9		1 7.1		6.9		1 6.1		
	CLKAB or CLKBA	A or B	6.9		1 7.4		6.8		1 6.1		
		BPAR or APAR parity feedthrough	8.5		1.5 8.1		7.3		1.5 6.6		
		BPAR or APAR parity generated	14.1		2.5 11.2		9.7		2 8.7		
		ERRA or ERRB	14.3		2.5 11.5		9.9		2 8.9		
	LEAB or LEBA	A or B	6.8		1 7		6.5		1 5.8		
		BPAR or APAR parity feedthrough	7.9		1.5 7.7		7		1.5 6.3		
		BPAR or APAR parity generated	13.6		2.5 10.8		9.3		2 8.4		
		ERRA or ERRB	13.5		2.5 10.9		9.5		2 8.5		
t _{en}	OEAB or OEBA	B, BPAR or A, APAR	6.8		1.4 7.3		7.1		1 6.3		ns
t _{dis}	OEAB or OEBA	B, BPAR or A, APAR	6.9		1.3 7.1		6.2		1.5 5.9		ns
t _{en}	OEAB or OEBA	ERRA or ERRB	7.4		1.4 7.2		6.5		1 5.9		ns
t _{dis}	OEAB or OEBA	ERRA or ERRB	9.3		1.3 8.3		7.5		1 6.7		ns
t _{en}	SEL	ERRA or ERRB	7.6		1.4 7.7		7.5		1 6.5		ns
t _{dis}	SEL	ERRA or ERRB	7.8		1.3 7.4		6.4		1.5 5.9		ns

[†] Texas Instruments SPICE simulation data

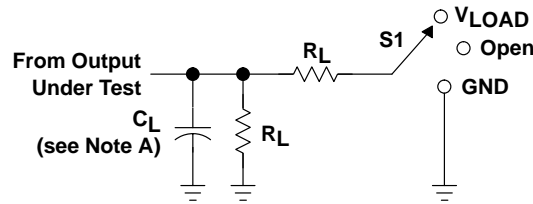
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18-BIT UNIVERSAL BUS TRANSCEIVER
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operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	
C_{pd} Power dissipation capacitance per transceiver	Outputs enabled	$f = 10\text{ MHz}$	37	52	68	pF
	Outputs disabled		16	22	28	

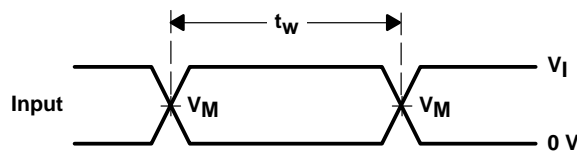
PARAMETER MEASUREMENT INFORMATION



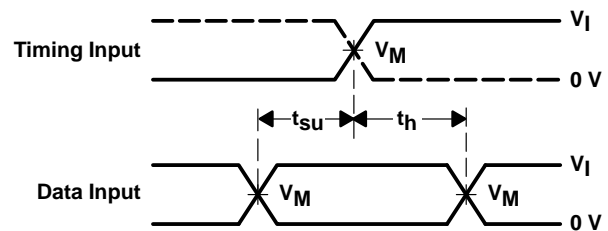
LOAD CIRCUIT

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

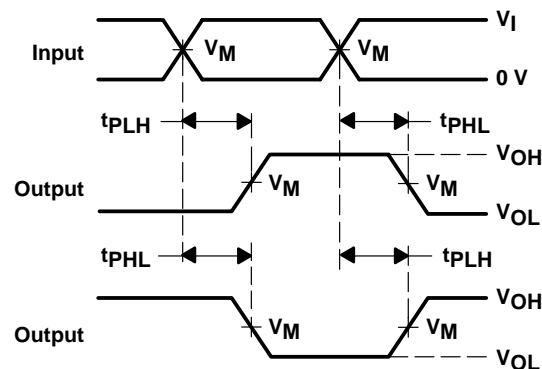
V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
$1.8\text{ V} \pm 0.15\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
$2.5\text{ V} \pm 0.2\text{ V}$	V_{CC}	$\leq 2\text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V
$3.3\text{ V} \pm 0.3\text{ V}$	2.7 V	$\leq 2.5\text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V



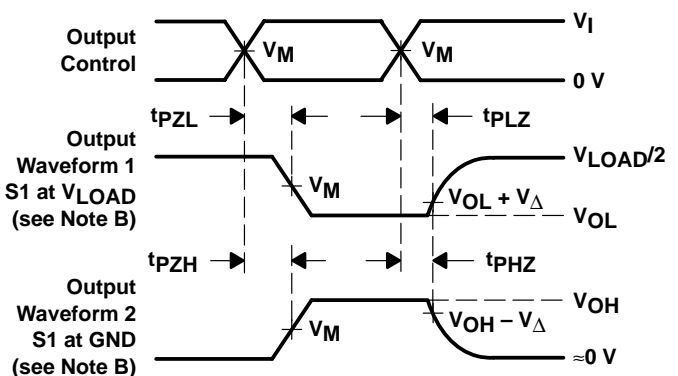
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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